POWERTIP *TECH. CORP.*

SPECIFICATIONS

CUSTOMER	:	HCN040
SAMPLE CODE	:	SC1601LRS-AWA-B-Q
MASS PRODUCTION CODE	:	PC1601LRS-AWA-B-Q
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	001
DRAWING NO. (Ver.)	:	JLMD-PC1601LRS-AWA-B-Q _001
PACKAGING NO. (Ver.)	:	JPKG -PC1601LRS-AWA-B-Q _001

Customer Approved

Date:

POWERTIP
2013.07.29
JS RD APPROVED
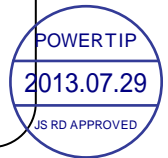
Approved	Checked	Designer
閆偉 Ryan	劉進 lori	李誠 Bruce

☐ Preliminary specification for design input

■ Specification for sample approval

POWERTIP TECH. CORP.

RECORDS OF REVISION

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
02/20/2004	01	0	Revised Contents	-	
07/24/2004	01	A	Update Weight and Outline Dimension	4	
08/14/2007	01	B	Update Timing Characteristics and Display Command	12,14	李遠東
07/25/2013	01	001	Update specification	-	李誠

Total：28 Pages

POWERTIP

Contents

Note：For detailed information please refer to IC data sheet：<u>ST7066U</u>

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16*1 characters
LCD Type	STN,Gray, Transflective, Positive ,Normal Temp.
Driver Condition	LCD Module：1/16 Duty，1/4 Bias
Viewing Direction	6 O'clock
Backlight	Yellow-Green LED B/L
Weight	35.8g
Interface	-
Other(controller / driver IC)	ST7066U
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer web site : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	80.0(L) * 36.0(w) * 14.0(H)	mm
Viewing Area	64.5(L) *13.8(w)	mm
Active Area	59.62(L) *6.56(w)	mm
Character Size	0.55(L) *0.75(w)	mm
Character Pitch	0.63(L) *0.83(w)	mm

Note：For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	-	-0.3	7.0	V
LCD Driver Supply Voltage	V_{LCD}	-	V_{DD}-10.0	V_{DD}+0.3	V
Input Voltage	V_{IN}	-	-0.3	V_{DD}+0.3	V
Operating Temperature	T_{OP}	-	0	50	℃
Storage Temperature	T_{ST}	-	-20	70	℃
Storage Humidity	H_D	Ta＜40 ℃	-	90	%RH

1.4 DC Electrical Characteristics

$V_{DD} = 5.0 \pm 0.5V$, $V_{SS} = 0V$, Ta = 25℃

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
"H" Input Voltage	V_{IH}	-	$0.7\ V_{DD}$	-	V_{DD}	V
"L" Input Voltage	V_{IL}	-	-0.3	-	0.6	V
"H" Output Voltage	V_{OH}	I_{OH}=-0.1mA	3.9	-	V_{DD}	V
"L" Output Voltage	V_{OL}	I_{OL}=+0.1mA	-	-	0.4	V
Supply Current	I_{DD} *1	V_{DD}=5.0V	-	1.5	3.0	mA
LCM Driver Voltage	V_{OP}*2	0℃	-	-	-	V
		25℃	4.3	4.5	4.7	
		50℃				

NOTE: *1 The Maximum current display

*2 The VOP test point is VDD–V0

1.5 Optical Characteristics
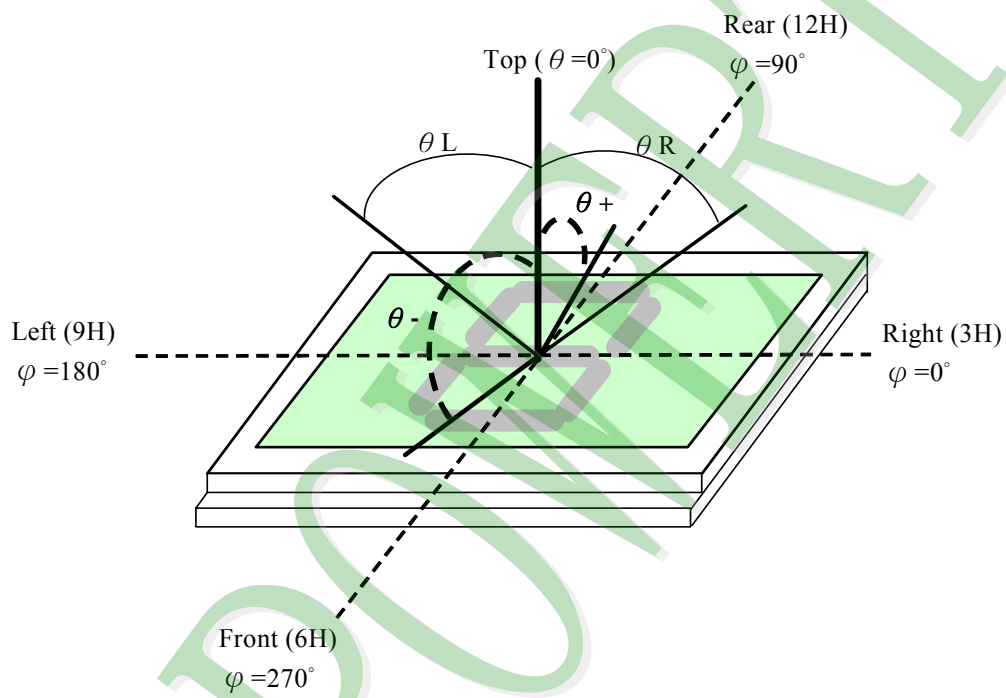
LCD Panel：1/16 Duty，1/4Bias，V_{LCD} =4.5V，Ta =25℃

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Reference
Response Time	Rise	tr		-	150	-	ms	Note2
	Fall	tf		-	300	-		
Viewing angle range	Top	Θ+	C>2.0, $\varnothing = 270°$	0	-	40	Deg.	Note 1
	Bottom	Θ-		0	-	40		
	Left	ΘL		0	-	45		
	Right	ΘR		0	-	45		
Contrast Ratio		C	$\theta = 0°$, $\varnothing = 270°$	5	7	-	-	Note 3

Note 1.

Optical characteristics-2

Viewing angle

Top (θ =0°)

Rear (12H)
φ =90°

θ L

θ R

θ +

θ -

Left (9H)
φ =180°

Right (3H)
φ =0°

Front (6H)
φ =270°

Viewing angle

Note 2.

Optical characteristics-3
     Fig.2 Definition of response time

Positive Type

No selected waveform → ← Selected waveform → ← No selected waveform

Transmittance

100%

90%

10%

Tr

Tf

Negative Type

No selected waveform → ← Selected waveform → ← No selected

Transmittance

100%

90%

10%

Tr

Tf
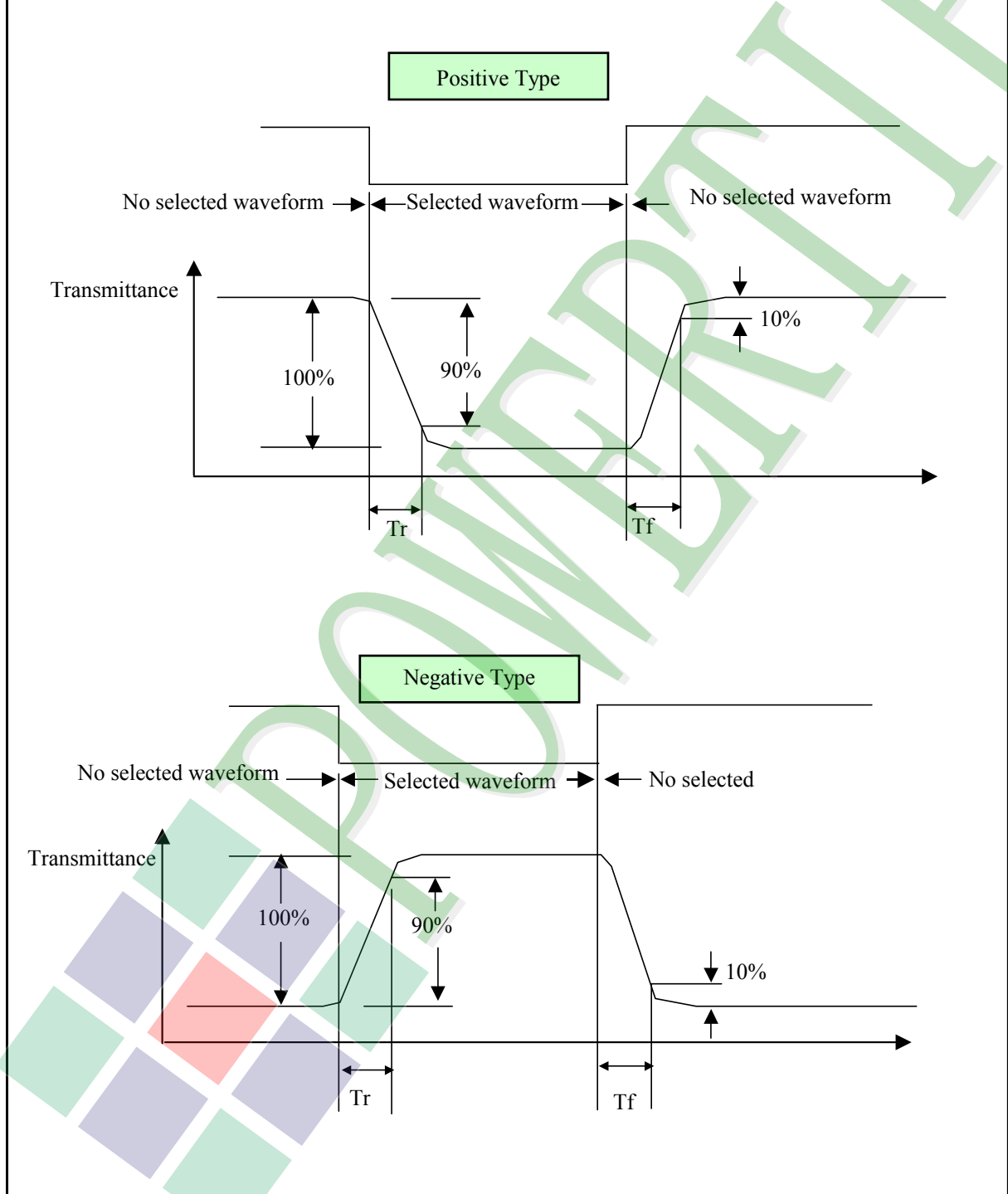
Electrical characteristics-2

　　※2 Drive waveform

　　Vop: Drive voltage　　fF: Frame frequency
　　1/B: Bias　　　　　　　fD: Drive frequency
　　N: Duty

(1) Selected waveform
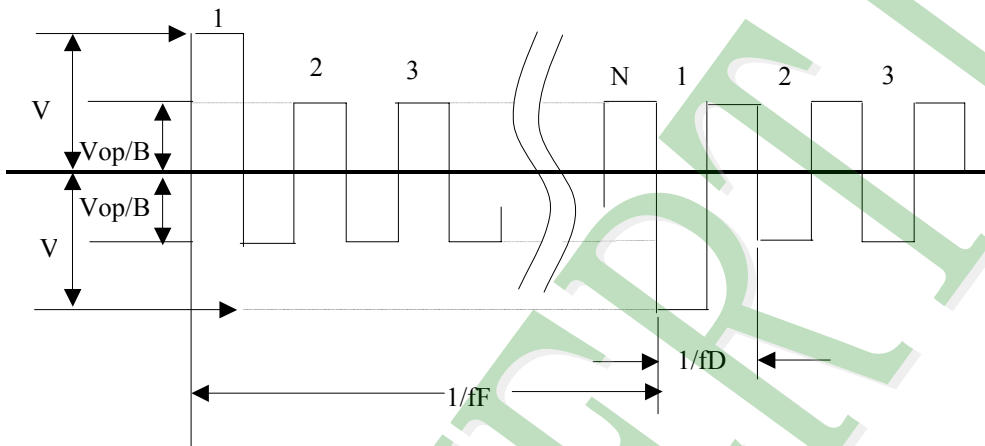
(2) Non- Selected wave form
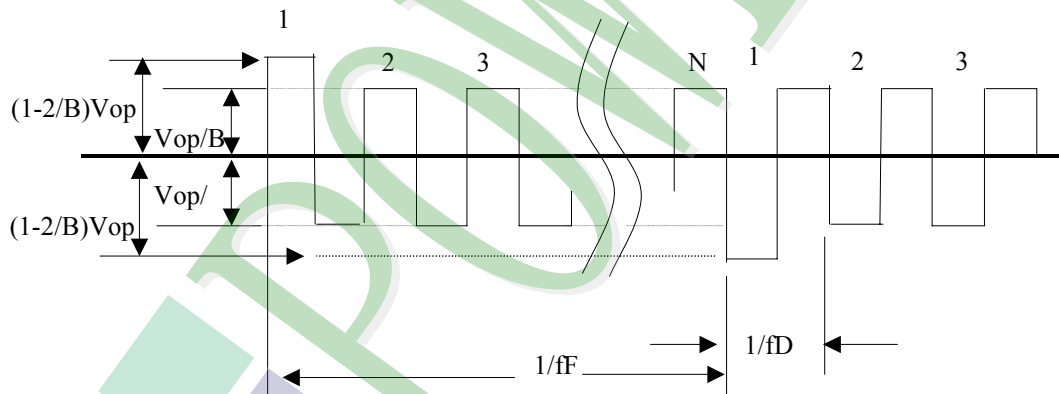
Note:
Frame frequency is defined as follows: Common side supply
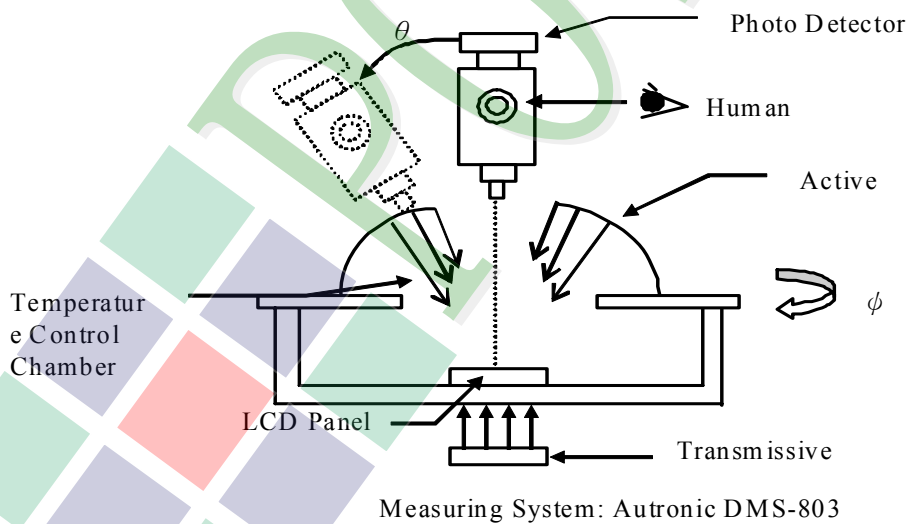voltage peak - to - peak /2 = 1 period

Note 3. : Definition of Vth
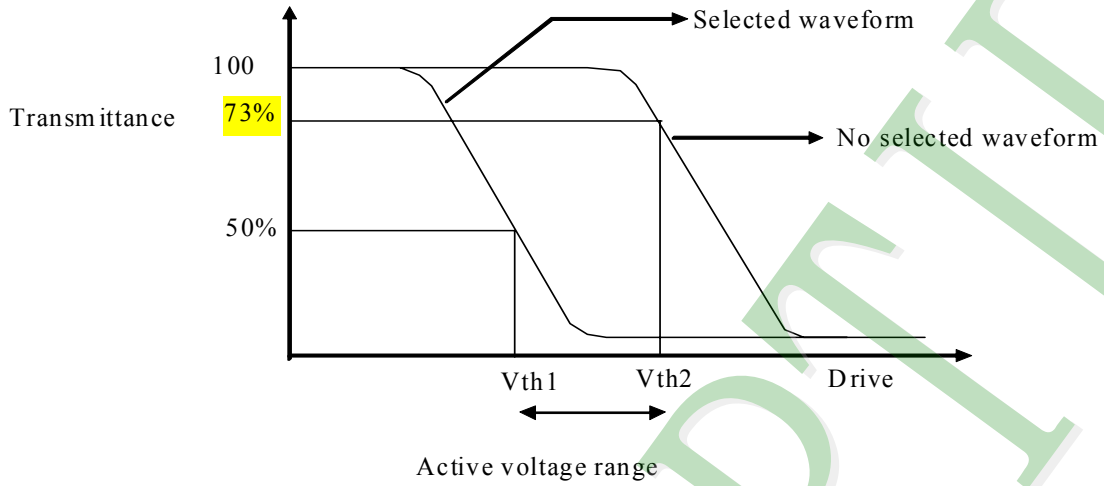
	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio
= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System

Measuring System: Autronic DMS-803

1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25℃	-	720	mA
Reverse Voltage	VR	Ta =25℃	-	10	V
Power Dissipation	PO	Ta =25℃	-	1.104	W

Electrical / Optical Characteristics   Ta =25℃

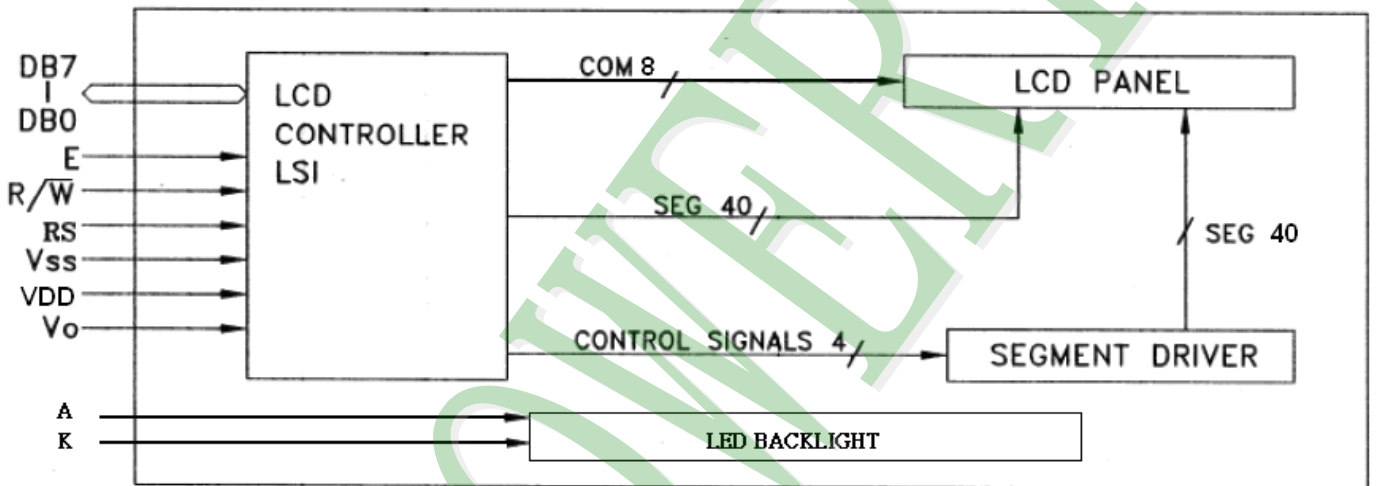| Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF= 120mA	3.9	4.2	4.6	V
Reverse Current	IR	VR=10V	-	-	1	mA
Average Brightness (without LCD)	Iv	IF= 150mA	220	-	-	cd/m2
Wavelength	Hue	IF=150mA	569	-	576	nm
Color	Yellow-Green					

2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram

2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	VSS	Power Supply (V_{SS}=0)
2	VDD	Power Supply (V_{DD}>V_{SS})
3	VO	Operating voltage for LCD.
4	RS	Register Selection input。High = Data register ；Low = Instruction register (for write)。 Busy flag address counter (for read)
5	R/$\overline{W}$	Read/Write signal input is used to select the read / write mode High = Read mode, Low = Write mode
6	E	Start enable signal to read or write the data
7~10	DB0~DB3	Four low order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module. These four are not used during 4-bit operation.
11~14	DB4~DB7	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module. DB7 can be used as a busy flag.
15	A	Power supply for LED backlight (+)
16	K	Power supply for LED backlight (-)

2.2.1 Application Notes

Contrast Adjust
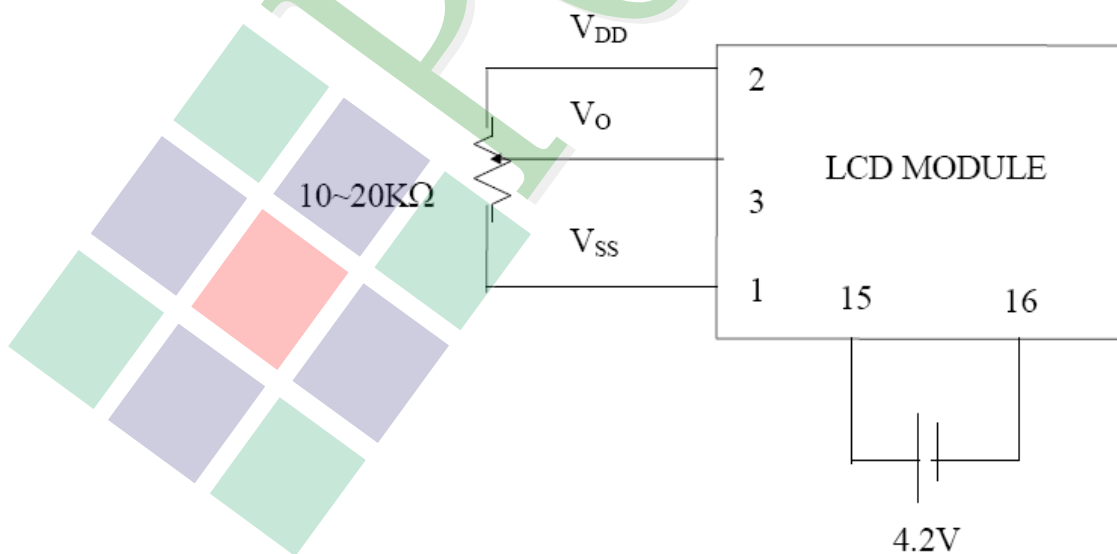
2.2.2 Refer Initial code

```
void initial()

{

delay(40);

write_com(0x3A);          // function set: 8-bit operation & dual line

delay(5);

write_com(0x02);          //display/cursor return home

delay(5);

write_com(0x0c);          //display on (D = C = 1, B = 0)

delay(5);

write_com(0x06);           //cursor shift right

delay(5);

write_com(0x01);           // clear display

delay(5);

}
```
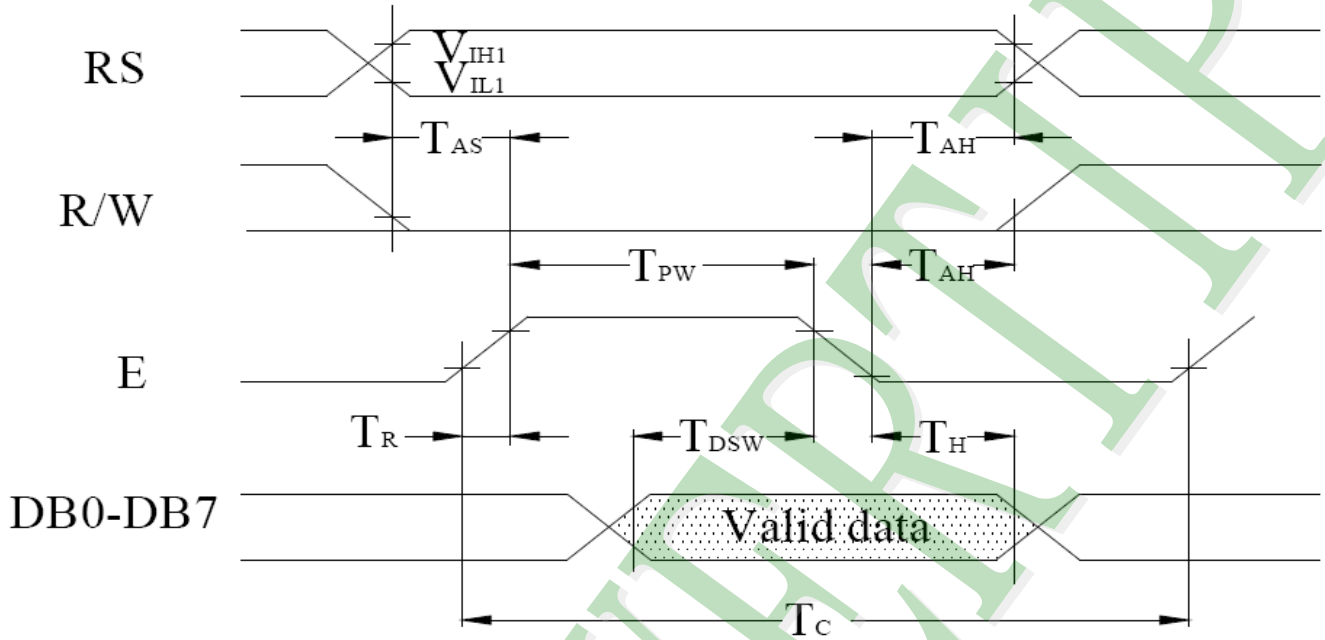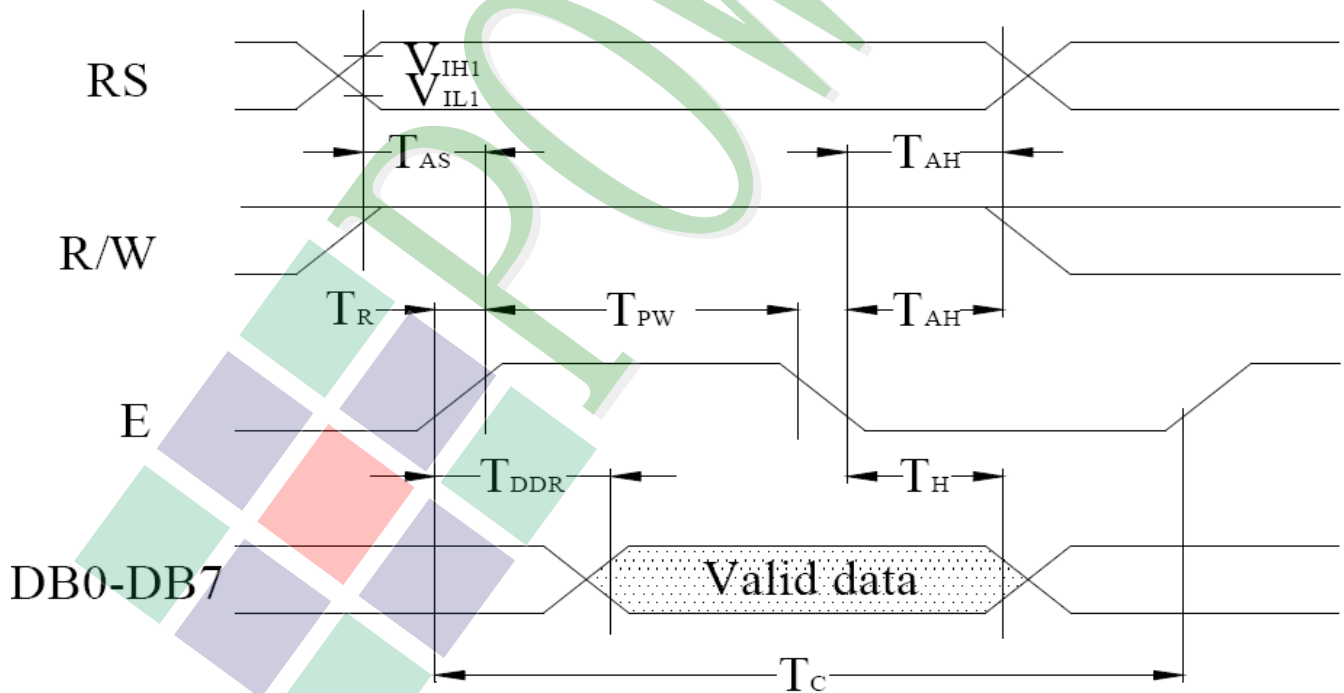
2.3 Timing Characteristics

● Writing data from MPU to ST7066U

● Reading data from ST7066U to MPU

- Write Mode (Writing data from MPU to ST7066U)

(VDD= +5V$\pm$10%,Ta=25°C)

| Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DSW}	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
T_H	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

- Read Mode (Reading data from ST7066U to MPU)

(VDD = +5V$\pm$10%,Ta=25°C)

| Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DDR}	Data Setup Time	Pins:DB0~DB7	-	-	100	ns
T_H	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

For 4-bit interface date,only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence
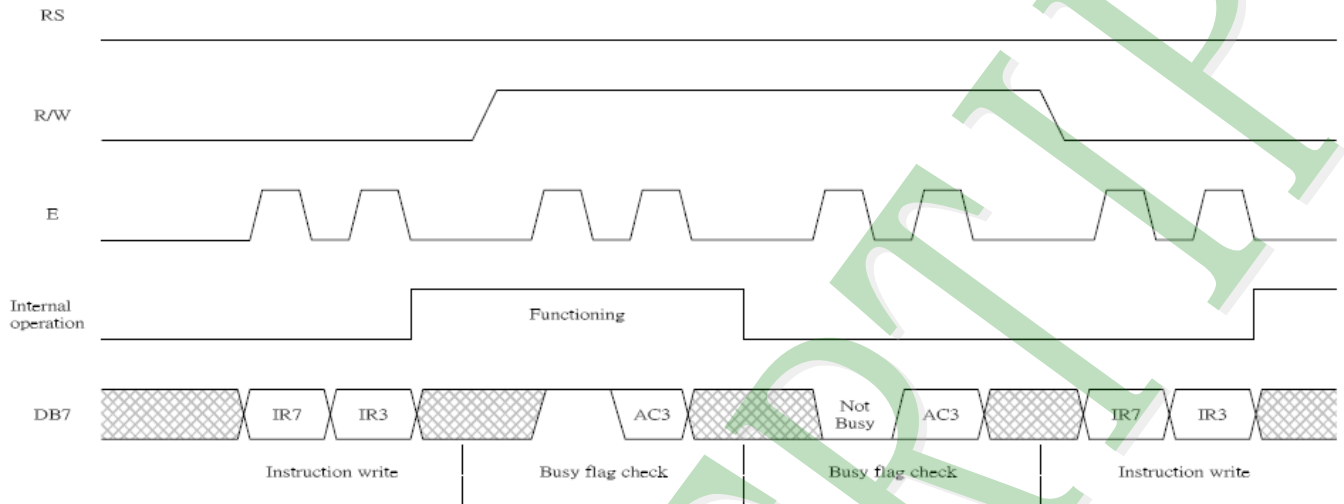
For 8-bitinterface date,all eight bus lines (DB0 to DB7) are used

Example of busy flag check timing sequence
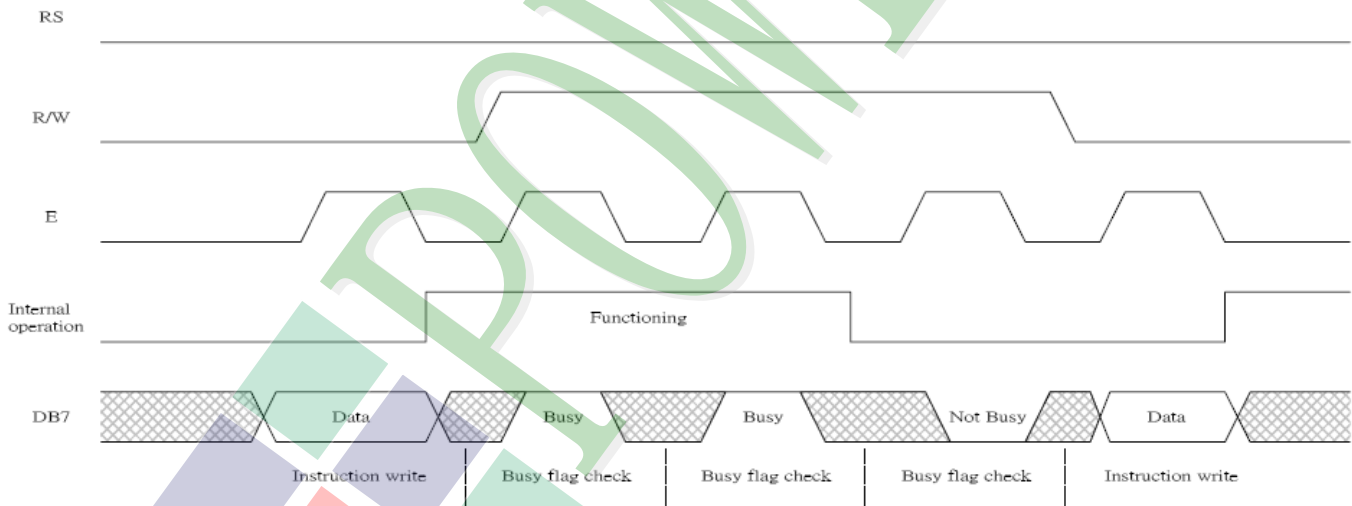
2.4 Display Command

Instruction Table:

Instruction	Instruction Code										Description	Description Time (270KHz)
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.52 ms
Return Home	0	0	0	0	0	0	0	0	1	x	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37 us
Display ON/OFF	0	0	0	0	0	0	1	D	C	B	D=1:entire display on C=1:cursor on B=1:cursor position on	37 us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	x	x	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37 us
Function Set	0	0	0	0	1	DL	N	F	x	x	DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8	37 us
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	37 us
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	37 us
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 us
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	37 us
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	37 us

Note:
Be sure the ST7066U is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.
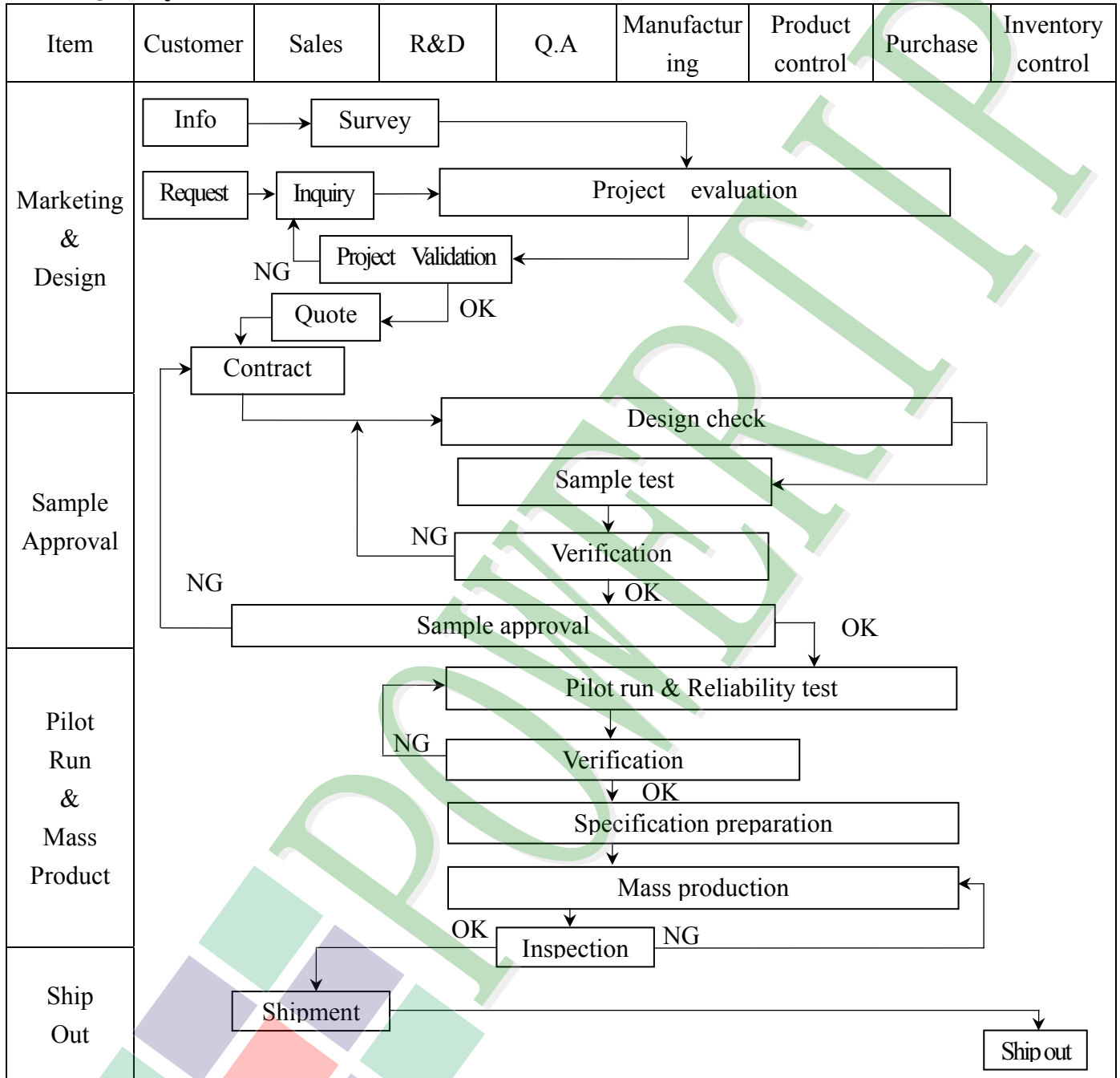
2.5 Character Pattern

Note:This model is designed by 5x8.The 2 bottom columns does not exist in fact.

3. QUALITY ASSURANCE SYSTEM

3.1   Quality Assurance Flow Chart

Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control

Marketing & Design

Info → Survey

Request → Inquiry → Project   evaluation

Project   Validation

NG

OK

Quote

Contract

Sample Approval

Design check

Sample test

NG

Verification

OK

NG

Sample approval   OK

Pilot Run & Mass Product

Pilot run & Reliability test

NG

Verification

OK

Specification preparation

Mass production

OK   Inspection   NG

Ship Out

Shipment

Ship out

Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

Sales Service flow:

Info → Claim → Failure analysis → Corrective action → Tracking; Failure analysis → Analysis report

3.2 Inspection Specification

◆Scope : The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level : Major Defect AQL：0.4 ; Minor Defect：AQL：1.5.

◆OUT Going Defect Level : Sampling .

◆Manner of appearance test :

（1）. The test be under 20W×2 fluorescent light ' and distance of view must be at 30 cm.

（2）. Standard of inspection： (Unit：mm)

（3）. The test direction is base on about around 45˚of vertical line. (Fig. 1)

（4）. Definition of area . (Fig. 2)

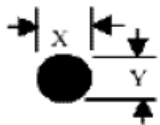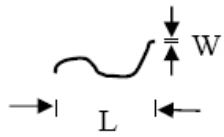B area : Outside of viewing area

eyes   eyes
45° 45°

Fig.1

Fig. 2   A area : viewing area
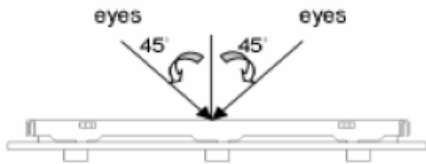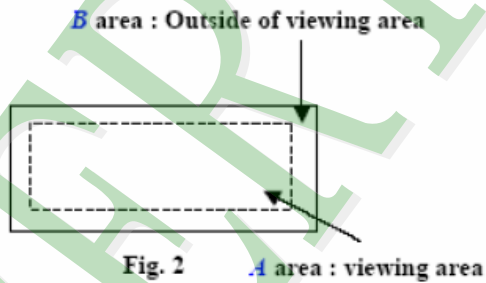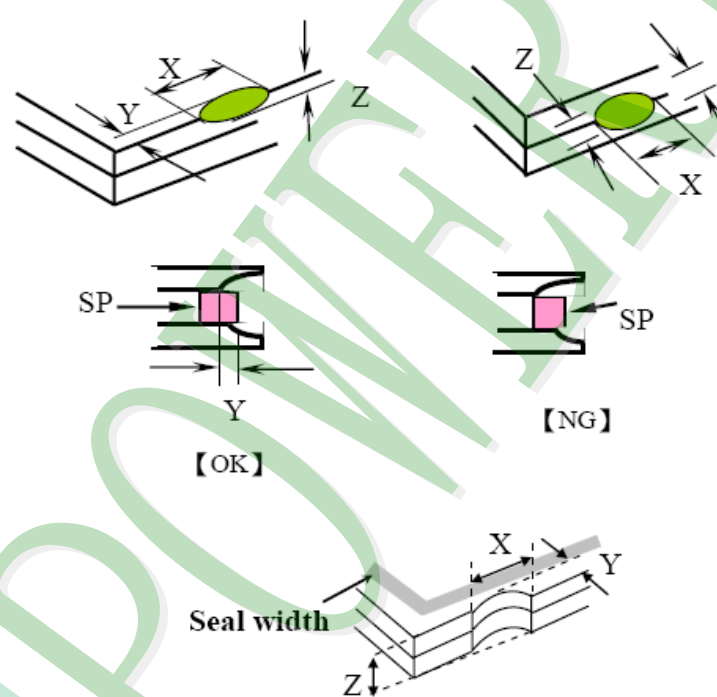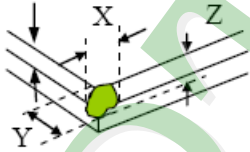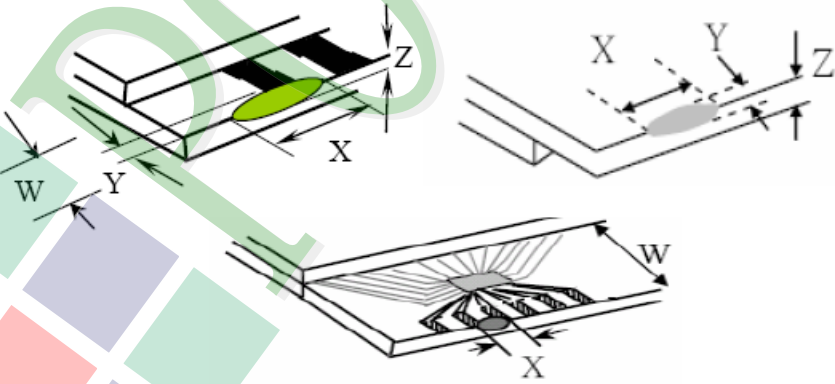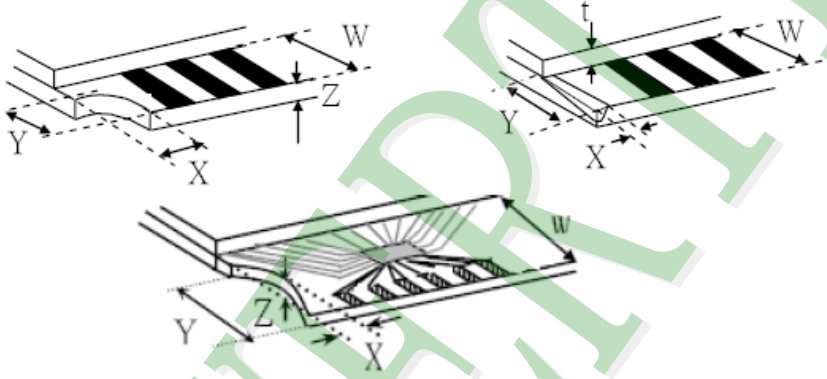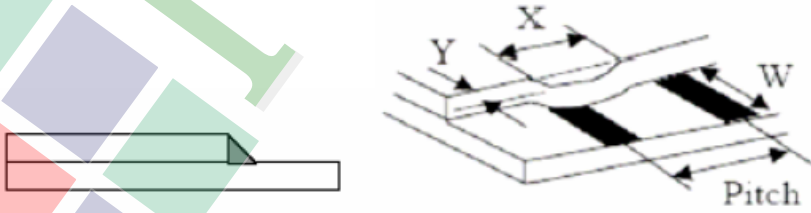
◆ Specification:

NO	Item	Criterion	Level
01	Product condition	1.1 The part number is inconsistent with work order of Production.	Major
		1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
04	Electrical Testing	4.1 Missing line character and icon.	Major
		4.2 No function or no display.	Major
		4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major

◆Specification For Monotype and Color STN： （Ver. B01）

NO	Item	Criterion	Level
05	**Black or white dot、scratch、contamination** **Round type** Φ=(x+y)/2 **Line type** 	5.1 Round type: 5.1.1 display only : ・White and black spots on display ≦ 0.30 mm , no more than 4 white or black spots present. ・Densely spaced : NO more than two spots or lines within 3 mm. 5.1.2 Non-display : (table below) 5.1.3 Line type: (table below)	Minor

5.1.2 Non-display :

Dimension (diameter : Φ)	Acceptance (Q'ty)	
	A area	B area
Φ ≦ 0.10	Accept no dense	Ignore
0.10 ＜ Φ ≦ 0.20	3	
0.20 ＜ Φ ≦ 0.30	2	
Total quantity	4	

5.1.3 Line type:

Dimension		Acceptance (Q'ty)	
Length (L)	Width (W)	A area	B area
---	W ≦ 0.03	Accept no dense	Ignore
L ≦ 3.0	0.03 ＜ W ≦ 0.05	4	
L ≦ 2.5	0.05 ＜ W ≦ 0.075		
---	W ＞ 0.075	As round type	

NO	Item	Criterion	Level
06	**Polarizer Bubble**	(table below)	Minor

Dimension (diameter : Φ)	Acceptance (Q'ty)	
	A area	B area
Φ ≦ 0.20	Accept no dense	Ignore
0.20 ＜ Φ ≦ 0.50	3	
0.50 ＜ Φ ≦ 1.00	2	
Φ ＞ 1.00	0	
Total quantity	4	

NO	Item	Criterion	Level
07	The crack of glass	Symbols： X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 7.1 General glass chip： 7.1.1 Chip on panel surface and crack between panels: 	Minor

X	Y	Z
$\leqq a$	Crack can't enter viewing area	$\leqq 1/2\ t$
$\leqq a$	Crack can't exceed the half of SP width.	$1/2\ t < Z\ \leqq 2\ t$

◆Specification For Monotype and Color STN : (Ver. B01)

NO	Item	Criterion	Level
07	The crack of glass	(see below)	Minor

Symbols :

X : The length of crack   Y : The width of crack.
Z : The thickness of crack   W : terminal length
t : The thickness of glass   a : LCD side length

7.1.2 Corner crack :

X	Y	Z
$\leqq 1/5\ a$	Crack can't enter viewing area	$Z \leqq 1/2\ t$
$\leqq 1/5\ a$	Crack can't exceed the half of SP width.	$1/2\ t < Z \leqq 2\ t$

7.2 Protrusion over terminal :

7.2.1 Chip on electrode pad :

	X	Y	Z
Front	$\leqq a$	$\leqq 1/2\ W$	$\leqq t$
Back	Neglect		

◆**Specification For Monotype and Color STN：** (Ver.B01)

NO	Item	Criterion	Level
07	The crack of glass	Symbols： X : The length of crack　　Y : The width of crack. Z : The thickness of crack　　W : terminal length t : The thickness of glass　　a : LCD side length 7.2.2 Non-conductive portion： | X	Y	Z
---	---	---
$\leqq 1/3\ a$	$\leqq W$	$\leqq t$ | ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 7.2.3 Glass remain： | X	Y	Z
---	---	---
$\leq a$	$\leq 1/3\ W$	$\leq t$		Minor

NO	Item	Criterion	Level
08	Backlight elements	8.1 Backlight can't work normally.	Major
		8.2 Backlight doesn't light or color is wrong.	Major
		8.3 Illumination source flickers when lit.	Major
09	General appearance	9.1 Pin type must match type in specification sheet.	Major
		9.2 No short circuits in components on PCB or FPC.	Major
		9.3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9.4 The folding and peeled off in polarizer are not acceptable.	Minor
		9.5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition   (Ver.B01)

NO.	TEST ITEM	TEST CONDITION
1	**High Temperature Storage Test**	Keep in +70 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	**Low Temperature Storage Test**	Keep in –20 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	**High Temperature / High Humidity Storage Test**	Keep in +40 ℃ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)
4	**Temperature Cycling Storage Test**	–20(min) → +25℃ → 70(max) → +25℃ (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.
5	**ESD Test**	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/- 1. Temperature ambiance : 15℃～35℃ 2. Humidity relative : 30%～60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)
6	**Vibration Test (Packaged)**	1. Sine wave 10～55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs
7	**Drop Test (Packaged)**	Packing Weight (Kg) / Drop Height (cm) table below Drop Direction :※1 corner / 3 edges / 6 sides each 1time

Drop Test table:

Packing Weight (Kg)	Drop Height (cm)
0 ~ 45.4	122
45.4 ~ 90.8	76
90.8 ~ 454	61
Over 454	46

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1   If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2   If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1   Avoid any strong mechanical shock which can break the glass.

5.2.2   Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3   Do not remove the panel or frame from the module.

5.2.4   The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5   Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6   Do not touch the display area with bare hands , this will stain the display area.

5.2.7   Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8   To control temperature and time of soldering is 320±10℃ and 3-5 sec.

5.2.9   To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

5.3.1   Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2   Do not place the module near organics solvents or corrosive gases.

5.3.3   Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1   Applicable warrant period
The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2   Unaccepted responsibility
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

NOTES:
1.LCD TYPE: STN,TRANSFLECTIVE,POSITIVE
2.Viewing Direction: 6 O'clock
3.Top:0~50°C Tst:-20~70°C
4.This product conforms ROHS
5.The tolerance unless classified ±0.3mm

Dimensions (main drawing):

36.0±0.5
31.0±0.15
27.44(FC)
13.8 (V.A)
6.56 (A.A)
2.5
4.28
11.1
(14.72)
P2.54*15=38.1
16-⌀1.0
33.9
2.0
1.8

(10.19)
3.95
7.75
2.5
59.62(A.A)
64.5(V.A)
72.1(FC)
75.0±0.15
80.0±0.5

PAD 4-⌀5.0
HOLE4-⌀2.5

14.0±0.5
9.4
1.6±0.15

SCALE:3/1

6.56
0.75
0.08
3.77
3.07
0.55
0.08

(3)

REV			Design	Check	Approve
007			Terry	Eddy	Ryan
006					
005					
004					
003					
002					
001	NEW DRAWING				
REV	REV BY				

REVISER	DATE
Terry	2013/07/24

PART NO.: PC1601LRS-AWA-B-Q
DRAWING NAME : JLMD-PC1601LRS-AWA-B-Q
TITLE: LCD MODULE DRAWING

Unit	Scale	Page
MM	1:1	1/1

Surface	Material	Thickness	Quantity

	Length (mm)	Precision
Tolerance	1 ~ 4	-
Precision	4 ~ 16	-
Level	16 ~ 63	-
	63 ~ 250	-
	250 ~ 1000	-

PT-A-054-01

Ver.001		LCM包裝規格書	Approve	Check	Contact
Documents NO.	JPKG-PC1601LRS-AWA-B-Q	LCM Packaging Specifications	Ryan	Eddy	Terry

1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (1)LCM	PC1601LRS-AWA-B-Q	80.0X36.0X14.0	0.0358	432	15.4656
2	靜電袋(2)Antistatic Bag	BAG100100ARABA	100 X 100	0.0011	432	0.4752
3	A1-1隔板(3)A1-1 Partition	BX29500047BZBA	295 X 47 X 3	0.0078	168	1.3104
4	B1-1隔板(4)B1-1 Partition	BX24500047BZBA	245 X 47 X 3	0.0065	48	0.312
5	氣泡紙(5)Bubble Sheet	BAG280240BWABA	280 X 240	0.006	24	0.144
6	C1內盒(6)Product Box	BX31025555AABA	310 X 255 X 55	0.13	12	1.56
7	外紙箱(7)Carton	BX52732536CCBA	527 X 325 X 360	0.83	1	0.83
8						
9						

2.一 整箱總重量 (Total LCD Weight in carton) :　　20.1　Kg±10%
3.單箱數量規格表 (Packaging Specifications and Quantity) :
　(1)Quantity Of Spacer :　A1-1隔板　X　14　,　B1-1隔板　X　4
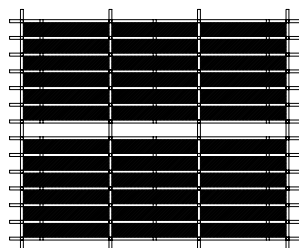　(2)Total LCM quantity in carton : quantity per box　　36　　x no of boxes　　12　　=　　432

(5) 氣泡紙 Bubble Sheet
(2)靜電袋+(1)LCM Antistatic Bag+LCM
(4) B1-1隔板 B1-1 Partition
(3) A1-1隔板 A1-1 Partition
(5) 氣泡紙 Bubble Sheet
(6) C1內盒 Product Box
(7)外紙箱 Carton
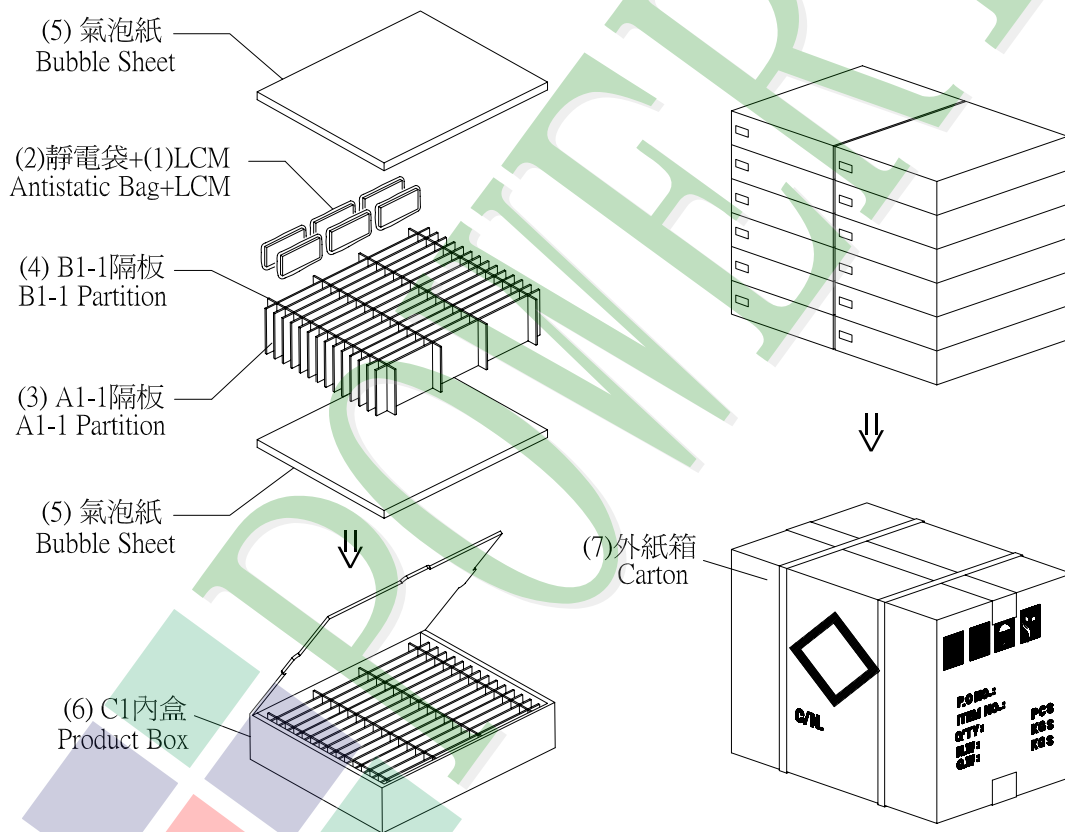
特　記　事　項 (REMARK)

4. Label Specifications :

參照廠內作業標準

5.LCM排放示意圖(前後間隔不放置):
5. LCM placed as figure showing:
(First and last slot should be empty)

前、中、后各空一格

▨ 模組(LCM) X 1pcs.